

$V_{DRM}$  = 4200 V  
 $I_{T(AV)M}$  = 3290 A  
 $I_{T(RMS)}$  = 5160 A  
 $I_{TSM}$  =  $54.0 \cdot 10^3$  A  
 $V_{TO}$  = 1.03 V  
 $r_T$  = 0.138 mΩ

# Phase Control Thyristor

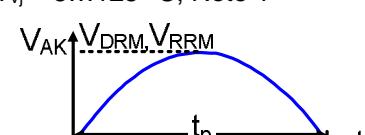
## 5STP 28L4200

Doc. No. 5SYA1009-06 Mar. 20

- Patented free-floating silicon technology
- Low on-state and switching losses
- Designed for traction, energy and industrial applications
- Optimum power handling capability
- Interdigitated amplifying gate

### Blocking

*Maximum rated values<sup>1)</sup>*

| Parameter  | Symbol                | Conditions  | 5STP 28L4200 |  | Unit |
|--|-----------------------|---|--------------|--|------|
| Max repetitive peak forward and reverse blocking voltage | $V_{DRM}$ , $V_{RRM}$ | $f = 50$ Hz, $t_p = 10$ ms,<br>$T_{vj} = 5 \dots 125$ °C, Note 1<br> | 4200         |  | V    |
| Critical rate of rise of commutating voltage             | $dv/dt_{crit}$        | Exp. to $0.67 \cdot V_{DRM}$ , $T_{vj} = 125$ °C  | 2000         |  | V/μs |

*Characteristic values*

| Parameter               | Symbol    | Conditions                    | min | typ | max | Unit |
|-------------------------|-----------|-------------------------------|-----|-----|-----|------|
| Forward leakage current | $I_{DRM}$ | $V_{DRM}$ , $T_{vj} = 125$ °C |     |     | 400 | mA   |
| Reverse leakage current | $I_{RRM}$ | $V_{RRM}$ , $T_{vj} = 125$ °C |     |     | 400 | mA   |

Note 1: Voltage de-rating factor of 0.11% per °C is applicable for  $T_{vj}$  below +5 °C.

### Mechanical data

*Maximum rated values<sup>1)</sup>*

| Parameter      | Symbol | Conditions       | min | typ | max | Unit             |
|----------------|--------|------------------|-----|-----|-----|------------------|
| Mounting force | $F_M$  |                  | 63  | 70  | 84  | kN               |
| Acceleration   | a      | Device unclamped |     |     | 50  | m/s <sup>2</sup> |
| Acceleration   | a      | Device clamped   |     |     | 100 | m/s <sup>2</sup> |

*Characteristic values*

| Parameter                 | Symbol         | Conditions                   | min   | typ | max   | Unit |
|---------------------------|----------------|------------------------------|-------|-----|-------|------|
| Weight                    | m              |                              |       |     | 1.45  | kg   |
| Housing thickness         | H              | $F_M = 70$ kN, $T_a = 25$ °C | 26.19 |     | 26.84 | mm   |
| Surface creepage distance | D <sub>s</sub> |                              | 36    |     |       | mm   |
| Air strike distance       | D <sub>a</sub> |                              | 15    |     |       | mm   |

1) Maximum rated values indicate limits beyond which damage to the device may occur

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**On-state****Maximum rated values<sup>1)</sup>**

| Parameter                         | Symbol       | Conditions   | min | typ | max               | Unit                 |
|-----------------------------------|--------------|--|-----|-----|-------------------|----------------------|
| Average on-state current          | $I_{T(AV)M}$ | Half sine wave, $T_c = 70^\circ C$                               |     |     | 3290              | A                    |
| RMS on-state current              | $I_{T(RMS)}$ |  |     |     | 5160              | A                    |
| Peak non-repetitive surge current | $I_{TSM}$    | $t_p = 10 \text{ ms}, T_{vj} = 125^\circ C$ ,<br>sine half wave, |     |     | $54.0 \cdot 10^3$ | A                    |
| Limiting load integral            | $I^2t$       | $V_D = V_R = 0 \text{ V}$ , after surge                          |     |     | $14.6 \cdot 10^6$ | $\text{A}^2\text{s}$ |
| Peak non-repetitive surge current | $I_{TSM}$    | $t_p = 10 \text{ ms}, T_{vj} = 125^\circ C$ ,<br>sine half wave, |     |     | $42.5 \cdot 10^3$ | A                    |
| Limiting load integral            | $I^2t$       | $V_R = 0.6 \cdot V_{RRM}$ , after surge                          |     |     | $9.03 \cdot 10^6$ | $\text{A}^2\text{s}$ |

**Characteristic values**

| Parameter         | Symbol     | Conditions  | min | typ  | max   | Unit             |
|-------------------|------------|---|-----|------|-------|------------------|
| On-state voltage  | $V_T$      | $I_T = 3000 \text{ A}, T_{vj} = 125^\circ C$                  |     | 1.35 | 1.45  | V                |
| Threshold voltage | $V_{(TO)}$ |   |     |      | 1.03  | V                |
| Slope resistance  | $r_T$      | $I_T = 2000 \text{ A} - 6000 \text{ A}, T_{vj} = 125^\circ C$ |     |      | 0.138 | $\text{m}\Omega$ |
| Holding current   | $I_H$      | $T_{vj} = 25^\circ C$   |     |      | 100   | mA               |
|                   |            | $T_{vj} = 125^\circ C$  |     |      | 60    | mA               |
| Latching current  | $I_L$      | $T_{vj} = 25^\circ C$   |     |      | 500   | mA               |
|                   |            | $T_{vj} = 125^\circ C$  |     |      | 300   | mA               |

**Switching****Maximum rated values<sup>1)</sup>**

| Parameter                                 | Symbol         | Conditions   | min                          | typ | max | Unit          |                        |
|---|----------------|--|------------------------------|-----|-----|---------------|------------------------|
| Critical rate of rise of on-state current | $di/dt_{crit}$ | $T_{vj} = 125^\circ C, I_T = 4000 \text{ A},$<br>$V_D \leq 0.67 \cdot V_{DRM},$<br>$I_{GM} = 2 \text{ A}, t_r = 0.5 \mu\text{s}$   | Cont.<br>$f = 50 \text{ Hz}$ |     |     | 250           | $\text{A}/\mu\text{s}$ |
|   |                |  | Cont.<br>$f = 1 \text{ Hz}$  |     |     | 1000          | $\text{A}/\mu\text{s}$ |
| Circuit-commutated turn-off time          | $t_q$          | $T_{vj} = 125^\circ C, I_T = 2000 \text{ A},$<br>$V_R = 200 \text{ V}, di_T/dt = -1.5 \text{ A}/\mu\text{s},$<br>$V_D \leq 0.67 \cdot V_{DRM}, dv_D/dt = 20 \text{ V}/\mu\text{s}$ |                              |     | 600 | $\mu\text{s}$ |                        |

**Characteristic values**

| Parameter                | Symbol   | Conditions  | min  | typ  | max  | Unit           |
|--------------------------|----------|---|------|------|------|----------------|
| Reverse recovery charge  | $Q_{rr}$ | $T_{vj} = 125^\circ C, I_T = 2000 \text{ A},$   | 2900 | 3650 | 4100 | $\mu\text{As}$ |
| Reverse recovery current | $I_{RM}$ | $V_R = 200 \text{ V}, di_T/dt = -1.5 \text{ A}/\mu\text{s}$                                     | 45   | 70   | 90   | A              |
| Gate turn-on delay time  | $t_{gd}$ | $T_{vj} = 25^\circ C, V_D = 0.4 \cdot V_{RM},$<br>$I_{GM} = 2 \text{ A}, t_r = 0.5 \mu\text{s}$ |      |      | 3    | $\mu\text{s}$  |

## Triggering

*Maximum rated values<sup>1)</sup>*

| Parameter                 | Symbol             | Conditions | min | typ | max | Unit |
|---------------------------|--------------------|------------|-----|-----|-----|------|
| Peak forward gate voltage | V <sub>FGM</sub>   |            |     |     | 12  | V    |
| Peak forward gate current | I <sub>FGM</sub>   |            |     |     | 10  | A    |
| Peak reverse gate voltage | V <sub>RGM</sub>   |            |     |     | 10  | V    |
| Average gate power loss   | P <sub>G(AV)</sub> | see Fig. 7 |     |     |     | W    |

*Characteristic values*

| Parameter                | Symbol          | Conditions  | min | typ | max | Unit |
|--------------------------|-----------------|---|-----|-----|-----|------|
| Gate-trigger voltage     | V <sub>GT</sub> | T <sub>vj</sub> = 25 °C   |     |     | 2.6 | V    |
| Gate-trigger current     | I <sub>GT</sub> | T <sub>vj</sub> = 25 °C   |     |     | 400 | mA   |
| Gate non-trigger voltage | V <sub>GD</sub> | V <sub>D</sub> = 0.4 · V <sub>DRM</sub> , T <sub>vjmax</sub> = 125 °C |     |     | 0.3 | V    |
| Gate non-trigger current | I <sub>GD</sub> | V <sub>D</sub> = 0.4 · V <sub>DRM</sub> , T <sub>vjmax</sub> = 125 °C |     |     | 10  | mA   |

## Thermal

*Maximum rated values<sup>1)</sup>*

| Parameter                            | Symbol           | Conditions | min | typ | max | Unit |
|--------------------------------------|------------------|------------|-----|-----|-----|------|
| Operating junction temperature range | T <sub>vj</sub>  |            |     |     | 125 | °C   |
| Storage temperature range            | T <sub>stg</sub> |            | -40 |     | 140 | °C   |

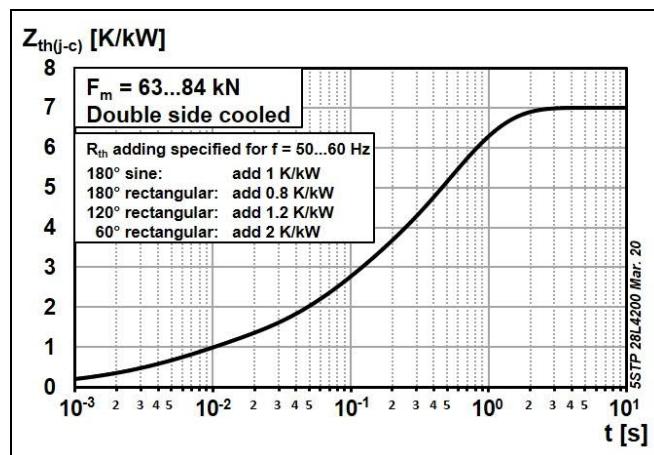
*Characteristic values*

| Parameter                            | Symbol                | Conditions  | min | typ | max | Unit |
|--------------------------------------|-----------------------|---|-----|-----|-----|------|
| Thermal resistance junction to case, | R <sub>th(j-c)</sub>  | Double-side cooled<br>F <sub>m</sub> = 63... 84 kN  |     |     | 7   | K/kW |
|                                      | R <sub>th(j-c)A</sub> | Anode-side cooled<br>F <sub>m</sub> = 63... 84 kN   |     |     | 14  | K/kW |
|                                      | R <sub>th(j-c)C</sub> | Cathode-side cooled<br>F <sub>m</sub> = 63... 84 kN |     |     | 14  | K/kW |
| Thermal resistance case to heatsink, | R <sub>th(c-h)</sub>  | Double-side cooled<br>F <sub>m</sub> = 63... 84 kN  |     |     | 1.5 | K/kW |
|                                      | R <sub>th(c-h)</sub>  | Single-side cooled<br>F <sub>m</sub> = 63... 84 kN  |     |     | 3   | K/kW |

**Analytical function for transient thermal impedance:**

$$Z_{th(j-c)}(t) = \sum_{i=1}^n R_i (1 - e^{-t/\tau_i})$$

| i                     | 1      | 2      | 3      | 4      |
|-----------------------|--------|--------|--------|--------|
| R <sub>i</sub> (K/kW) | 4.774  | 1.416  | 0.726  | 0.084  |
| τ <sub>i</sub> (s)    | 0.5266 | 0.0613 | 0.0055 | 0.0011 |



**Fig. 1** Transient thermal impedance (junction-to-case) vs. time

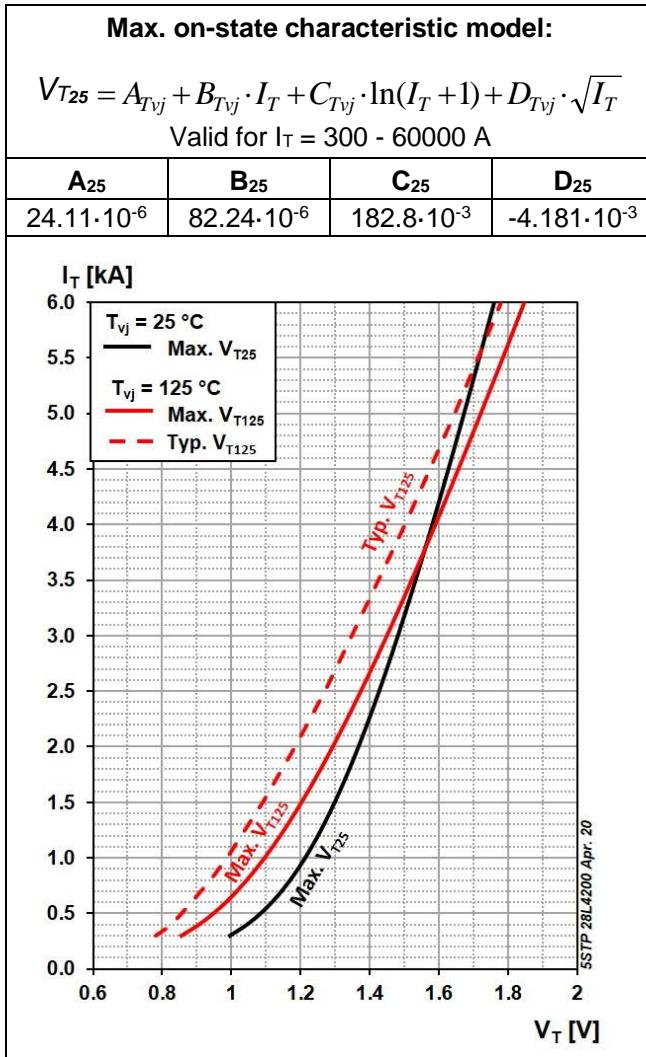


Fig. 2 On-state voltage characteristics

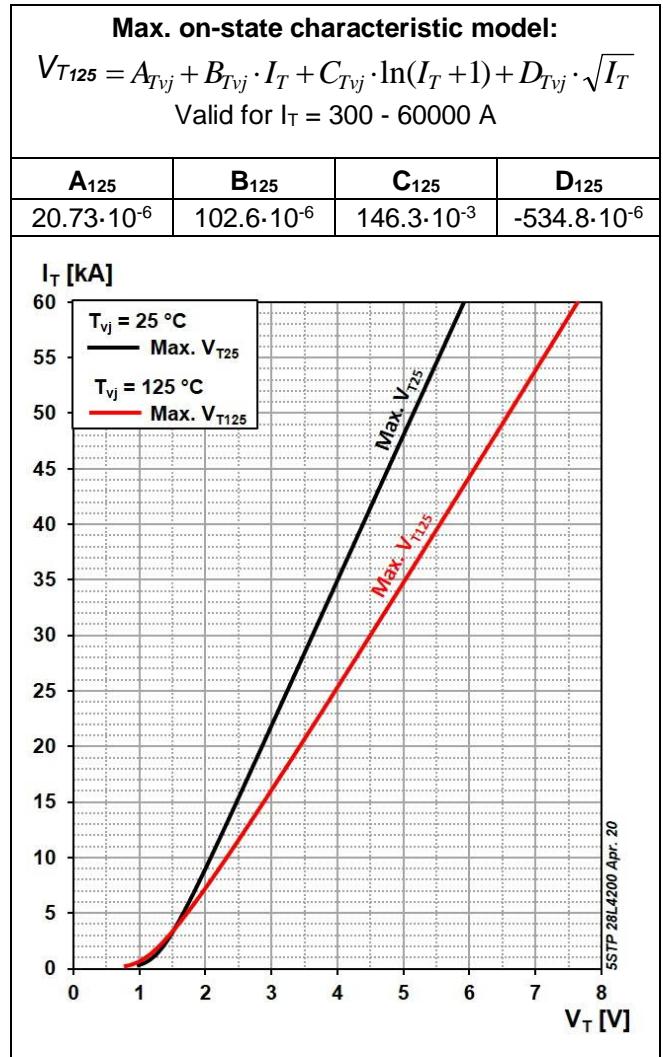


Fig. 3 On-state voltage characteristics

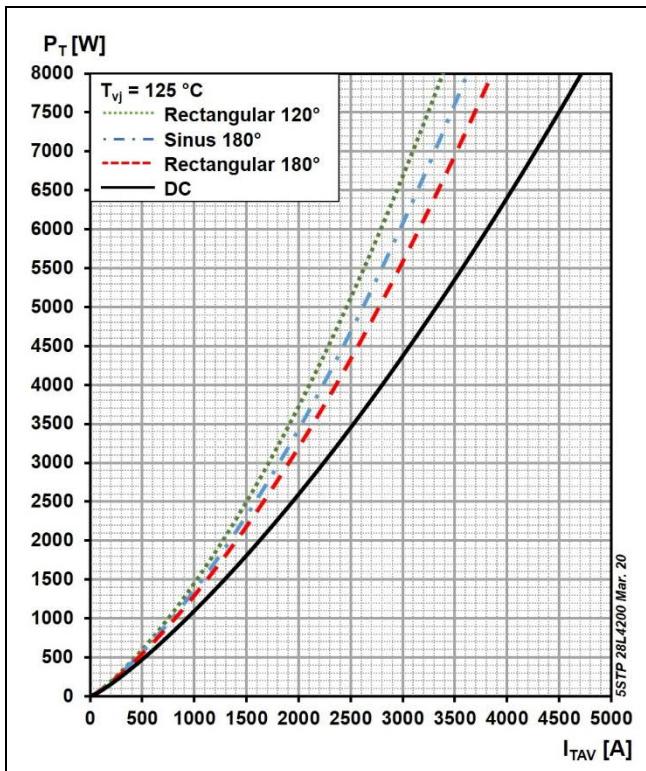


Fig. 4 On-state power dissipation vs. mean on-state current, turn-on losses excluded

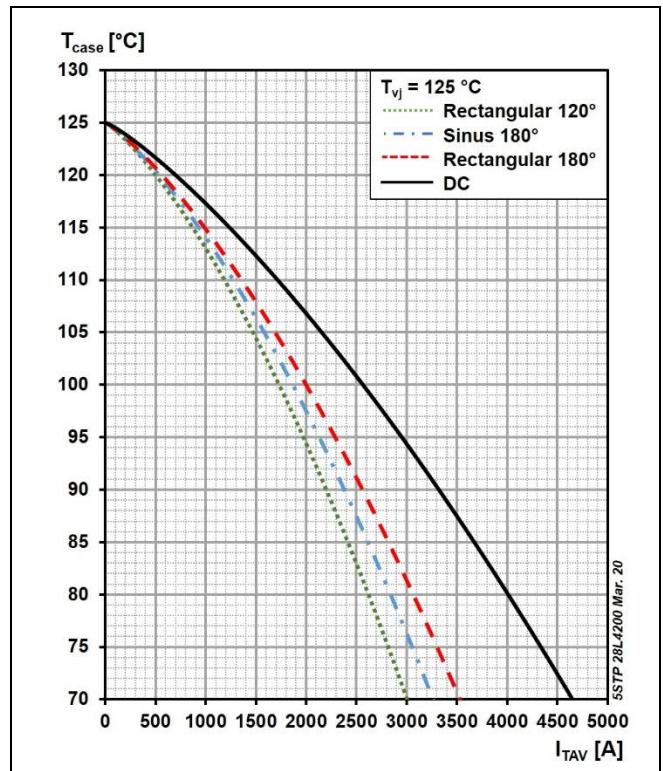


Fig. 5 Max. permissible case temperature vs. mean on-state current, switching losses ignored

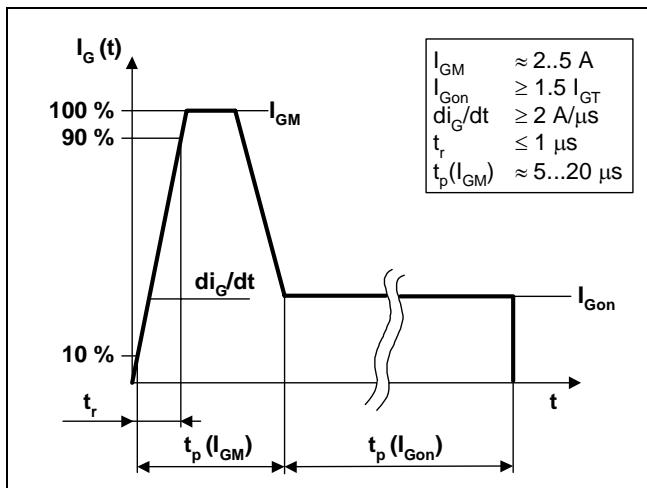


Fig. 6 Recommended gate current waveform

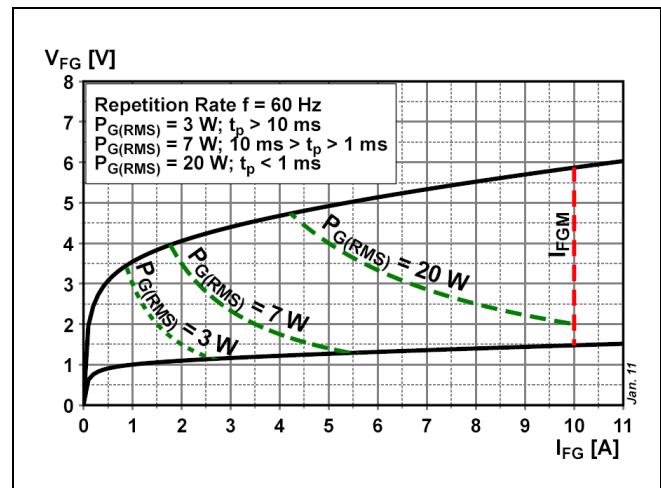


Fig. 7 Max. peak gate power loss

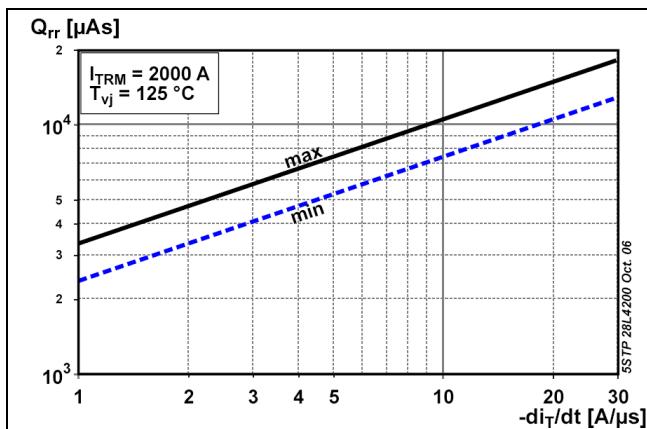


Fig. 8 Reverse recovery charge vs. decay rate of on-state current

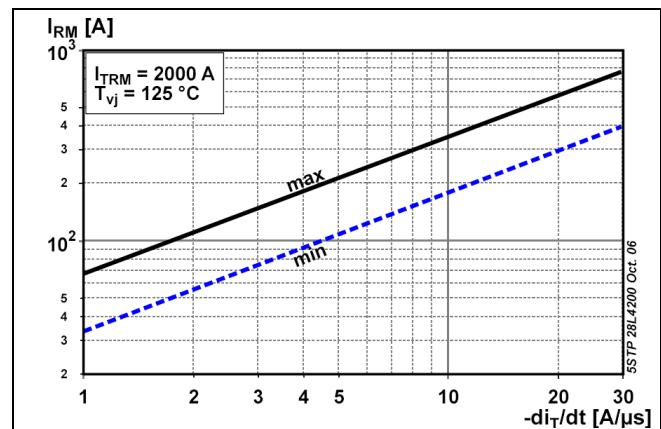


Fig. 9 Peak reverse recovery current vs. decay rate of on-state current

## Turn-on and Turn-off losses

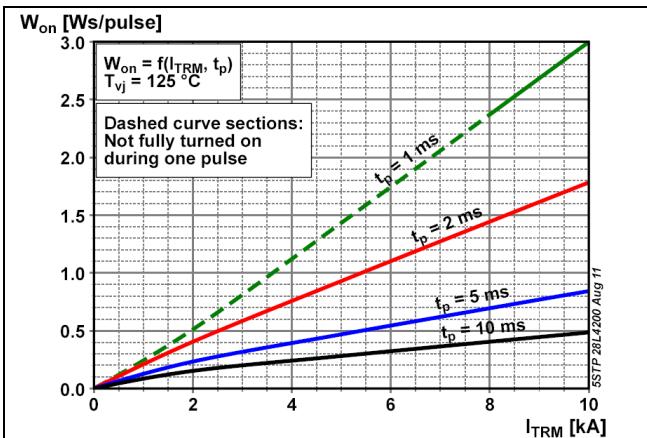


Fig. 10 Turn-on energy, half sinusoidal waves

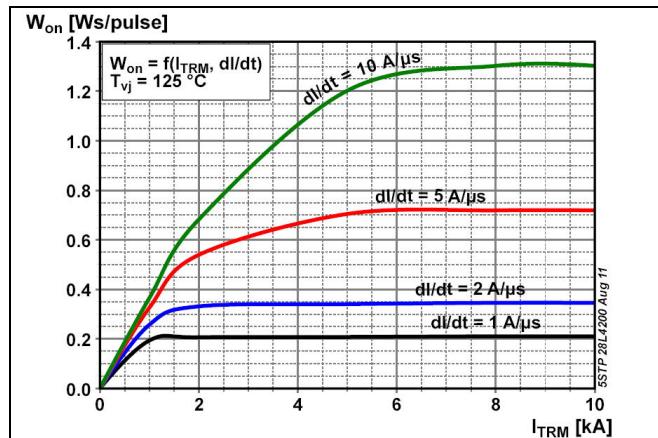


Fig. 11 Turn-on energy, rectangular waves

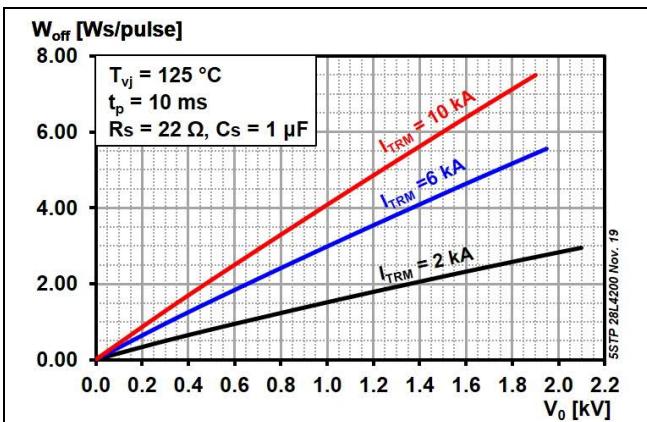


Fig. 12 Typical turn-off energy, half sinusoidal waves

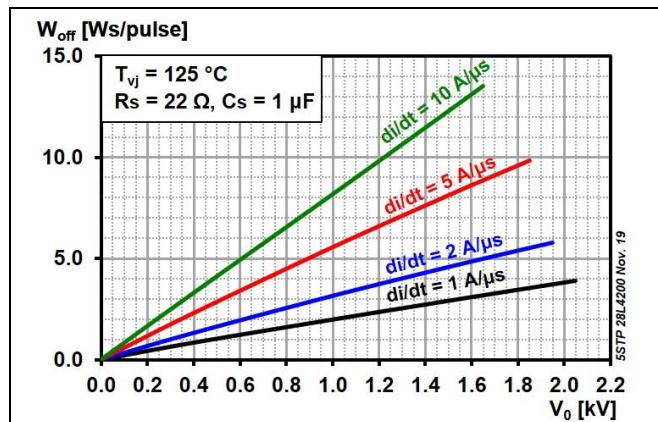


Fig. 13 Typical turn-off energy, rectangular waves

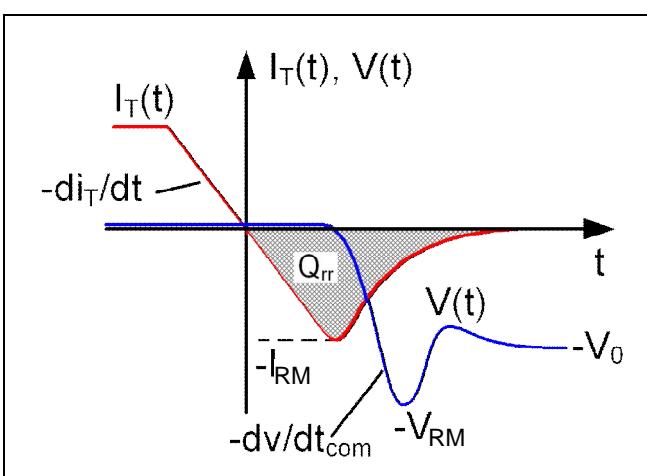


Fig. 14 Current and voltage waveforms at turn-off

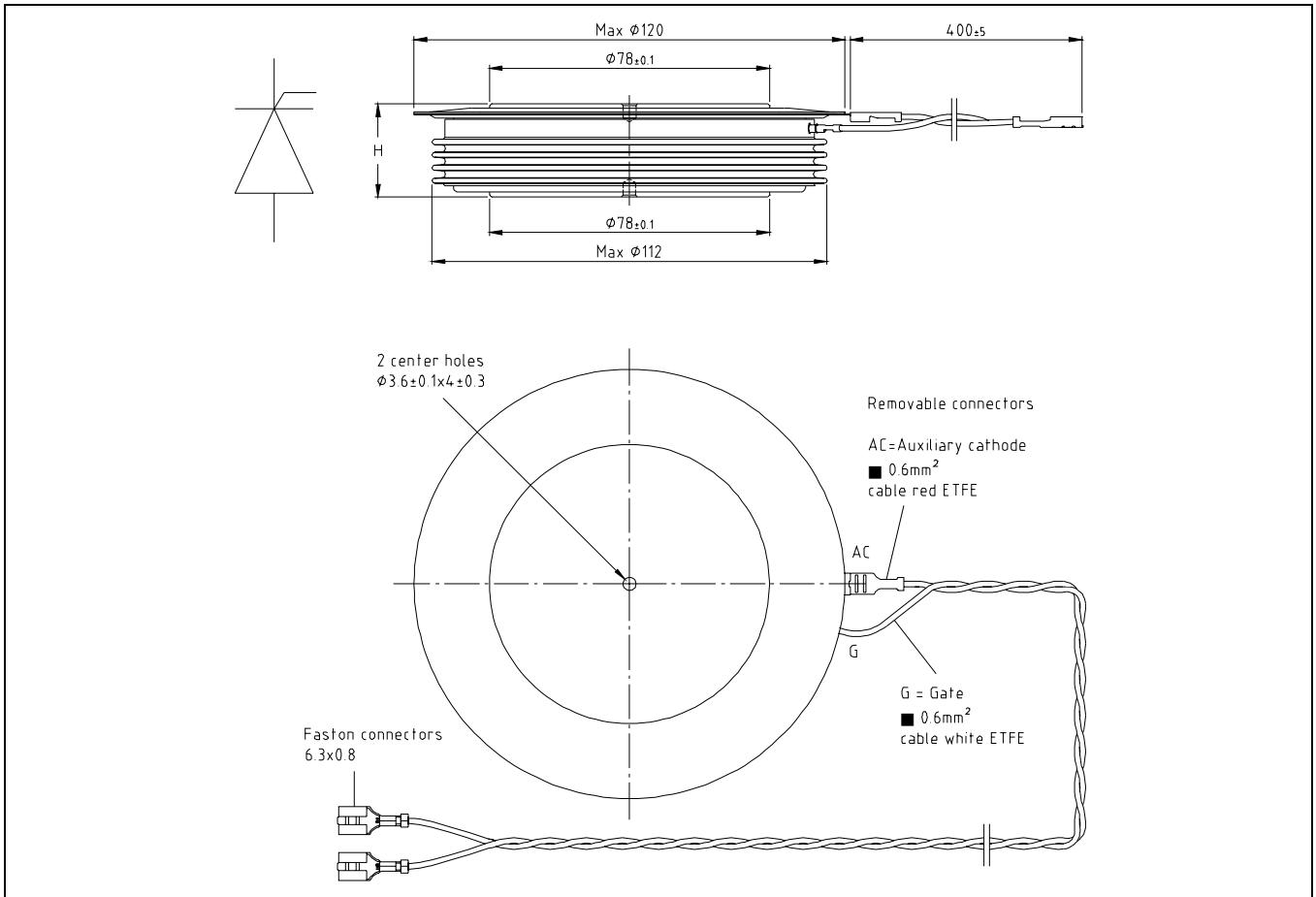
**Total power loss for repetitive waveforms:**

$$P_{TOT} = P_T + W_{on} \cdot f + W_{off} \cdot f$$

where

$$P_T = \frac{1}{T} \int_0^T I_T \cdot V_T(I_T) dt$$

Fig. 15 Relationships for power loss



**Fig. 16** Device Outline Drawing

### Related documents:

- 5SYA 2020 Design of RC-Snubbers for Phase Control Applications
- 5SYA 2049 Voltage definitions for phase control and bi-directionally controlled thyristors
- 5SYA 2051 Voltage ratings of high power semiconductors
- 5SYA 2034 Gate-drive recommendations for phase control and bi-directionally controlled thyristors
- 5SYA 2036 Recommendations regarding mechanical clamping of Press-Pack High Power Semiconductors
- 5SYA 2102 Surge currents for Phase Control Thyristors
- 5SZK 9118 General Environmental Conditions for High Power Semiconductors

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